

# 30V P-Channel MOSFETs

## RC2409

### General Description

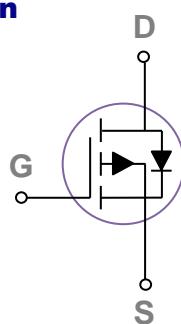
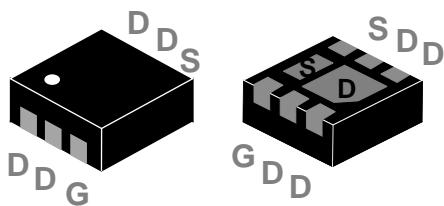
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDS(ON)	ID
-30V	30mΩ	-12A

### Features

- -30V,-12A, RDS(ON) =30mΩ@VGS = -10V
- Fast switching
- Green Device Available
- Suit for -4.5V Gate Drive Applications

### DFN2x2-6L 2EP Pin Configuration



### Applications

- Notebook
- Load Switch
- Battery Protection
- Hand-held Instruments

### Absolute Maximum Ratings T<sub>c</sub>=25°C unless otherwise noted

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	-30	V
V <sub>GS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Drain Current – Continuous (T <sub>c</sub> =25°C)	-12	A
	Drain Current – Continuous (T <sub>c</sub> =100°C)	-7.6	A
	Drain Current – Continuous (T <sub>A</sub> =25°C)	-6.1	A
	Drain Current – Continuous (T <sub>A</sub> =70°C)	-4.8	A
I <sub>DM</sub>	Drain Current – Pulsed <sup>1</sup>	-48	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	39.2	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	28	A
P <sub>D</sub>	Power Dissipation (T <sub>c</sub> =25°C)	7.1	W
	Power Dissipation – Derate above 25°C	0.06	W/°C
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	-55 to 150	°C

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction to ambient	---	62	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction to Case	---	17.5	°C/W

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## RC2409

**Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)**

### Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-30	---	---	V
△BV <sub>DSS</sub> /△T <sub>J</sub>	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =-1mA	---	-0.03	---	V/°C
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =-30V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C	---	---	-1	uA
		V <sub>DS</sub> =-24V , V <sub>GS</sub> =0V , T <sub>J</sub> =125°C	---	---	-10	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V	---	---	±100	nA

### On Characteristics

R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =-10V , I <sub>D</sub> =-4A	---	25	30	mΩ
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-2A	---	35	46	mΩ
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-1.2	-1.5	-2.2	V
			---	4	---	mV/°C
gfs	Forward Transconductance	V <sub>DS</sub> =-10V , I <sub>D</sub> =-1A	---	4	---	S

### Dynamic and switching Characteristics

Q <sub>g</sub>	Total Gate Charge <sup>3, 4</sup>	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-5A	---	8	15	nC
Q <sub>gs</sub>	Gate-Source Charge <sup>3, 4</sup>		---	3.3	6	
Q <sub>gd</sub>	Gate-Drain Charge <sup>3, 4</sup>		---	2.3	5	
T <sub>d(on)</sub>	Turn-On Delay Time <sup>3, 4</sup>	V <sub>DD</sub> =-15V , V <sub>GS</sub> =-10V , R <sub>G</sub> =6Ω I <sub>D</sub> =-1A	---	4.6	9	ns
T <sub>r</sub>	Rise Time <sup>3, 4</sup>		---	14	26	
T <sub>d(off)</sub>	Turn-Off Delay Time <sup>3, 4</sup>		---	34	58	
T <sub>f</sub>	Fall Time <sup>3, 4</sup>		---	18	35	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , F=1MHz	---	757	1280	pF
C <sub>oss</sub>	Output Capacitance		---	122	210	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	88	175	

### Drain-Source Diode Characteristics and Maximum Ratings

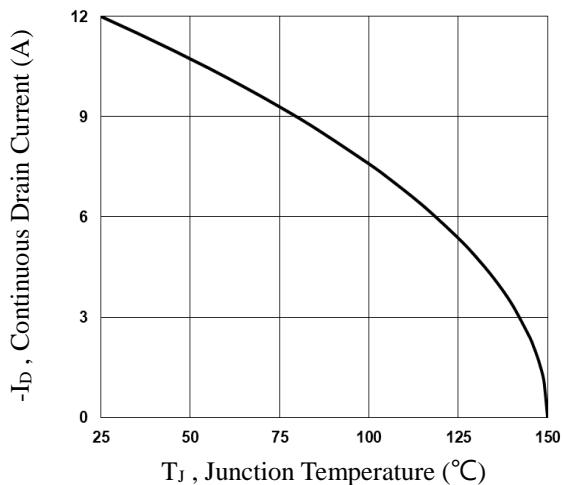
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>s</sub>	Continuous Source Current	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current	---	---	-12	A
I <sub>SM</sub>	Pulsed Source Current		---	---	-24	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>s</sub> =-1A , T <sub>J</sub> =25°C	---	---	-1	V

Note :

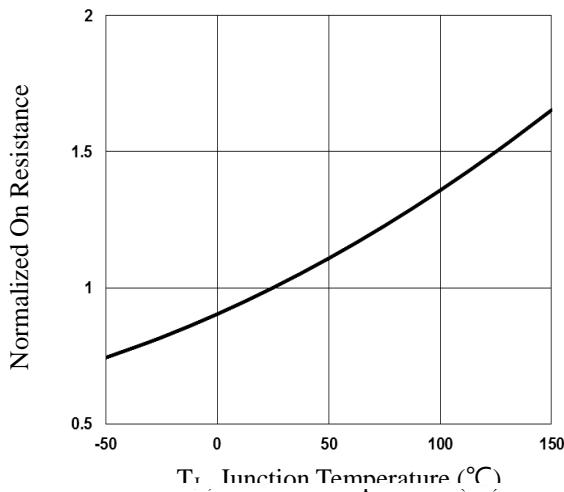
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V<sub>DD</sub>=25V,V<sub>GS</sub>=10V,L=0.1mH,I<sub>AS</sub>=28A.,R<sub>G</sub>=25Ω,Starting T<sub>J</sub>=25°C.
3. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%.
4. Essentially independent of operating temperature.

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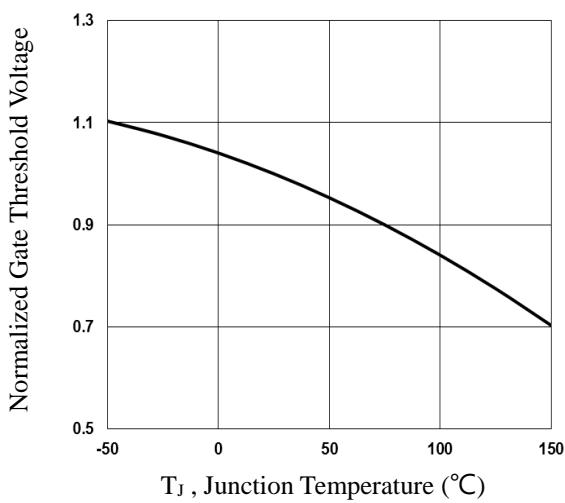
## RC2409



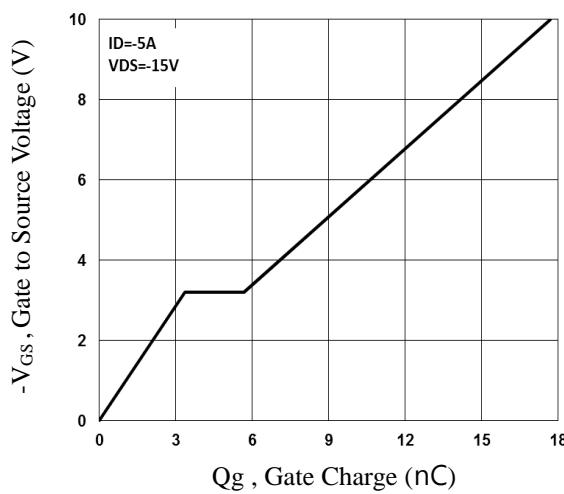
**Fig.1** Continuous Drain Current vs.  $T_c$



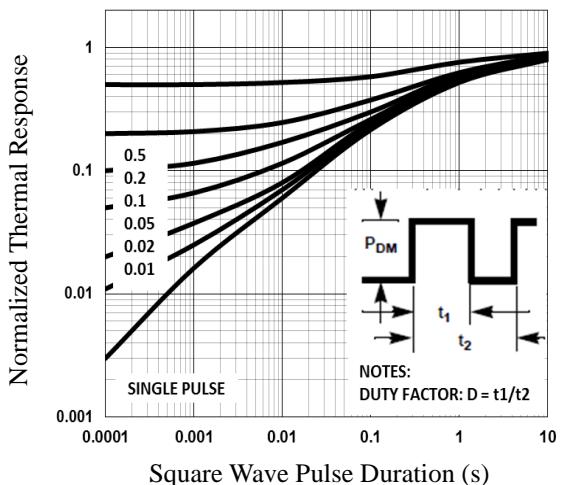
**Fig.2** Normalized RD<sub>SON</sub> vs.  $T_J$



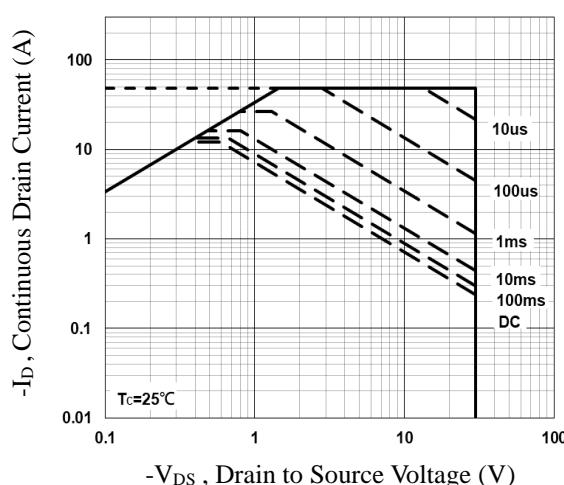
**Fig.3** Normalized  $V_{th}$  vs.  $T_J$



**Fig.4** Gate Charge Waveform



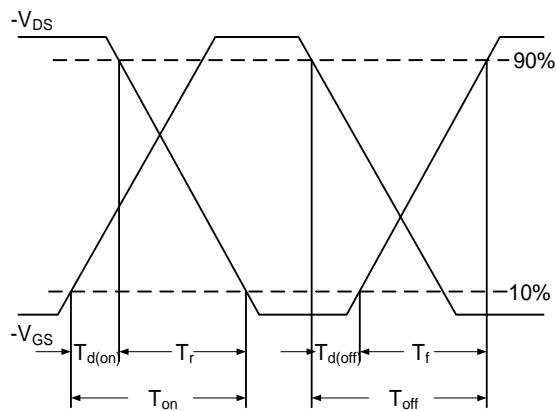
**Fig.5** Normalized Transient Impedance



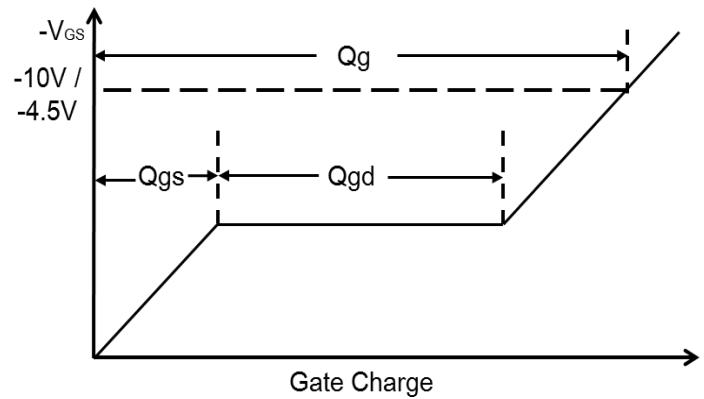
**Fig.6** Maximum Safe Operation Area

# 30V P-Channel MOSFETs

## RC2409



**Fig.7 Switching Time Waveform**

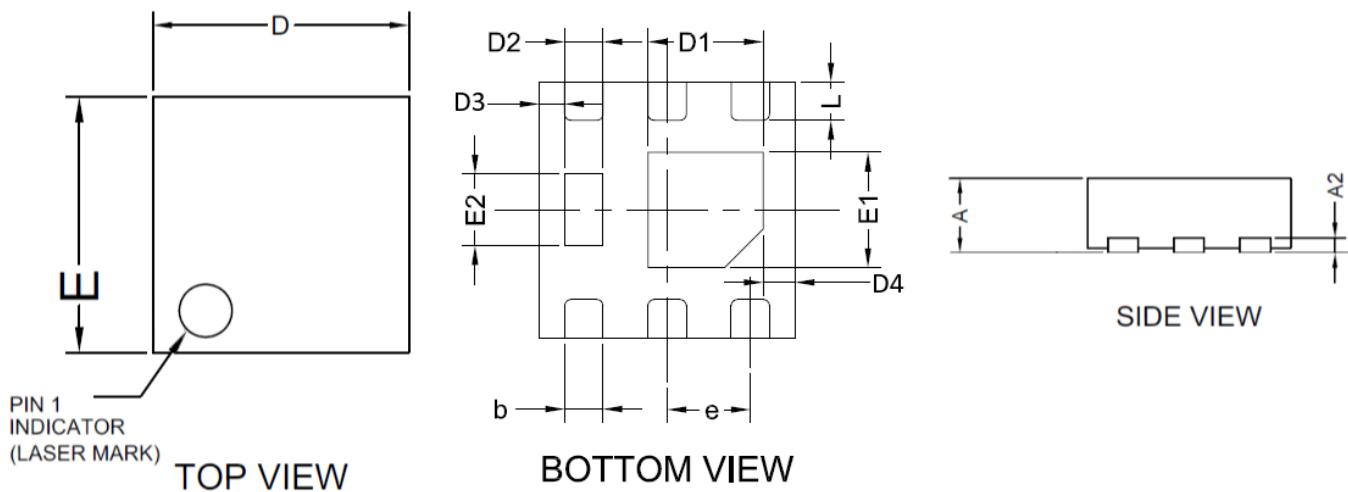


**Fig.8 Gate Charge Waveform**

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## RC2409

### DFN2x2-6L 2EP PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MAX	MIN	MAX	MIN
<b>A</b>	<b>0.800</b>	<b>0.500</b>	<b>0.031</b>	<b>0.019</b>
<b>A2</b>	<b>0.250</b>	<b>0.145</b>	<b>0.010</b>	<b>0.006</b>
<b>b</b>	<b>0.350</b>	<b>0.250</b>	<b>0.014</b>	<b>0.010</b>
<b>D</b>	<b>2.100</b>	<b>1.900</b>	<b>0.083</b>	<b>0.075</b>
<b>D1</b>	<b>1.000</b>	<b>0.800</b>	<b>0.040</b>	<b>0.031</b>
<b>D2</b>	<b>0.350</b>	<b>0.250</b>	<b>0.014</b>	<b>0.010</b>
<b>D3</b>	<b>0.200BSC</b>		<b>0.008BSC</b>	
<b>D4</b>	<b>0.200BSC</b>		<b>0.008BSC</b>	
<b>E</b>	<b>2.100</b>	<b>1.900</b>	<b>0.083</b>	<b>0.075</b>
<b>E1</b>	<b>1.050</b>	<b>0.800</b>	<b>0.041</b>	<b>0.031</b>
<b>E2</b>	<b>0.66</b>	<b>0.46</b>	<b>0.026</b>	<b>0.018</b>
<b>e</b>	<b>0.650BSC</b>		<b>0.026BSC</b>	
<b>L</b>	<b>0.350</b>	<b>0.250</b>	<b>0.014</b>	<b>0.010</b>